MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : **MI0570JT-1**

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.0
Engineering	
Date	2008-09-16
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2008-09-16	First Release	



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■ GENERAL INFORMATION

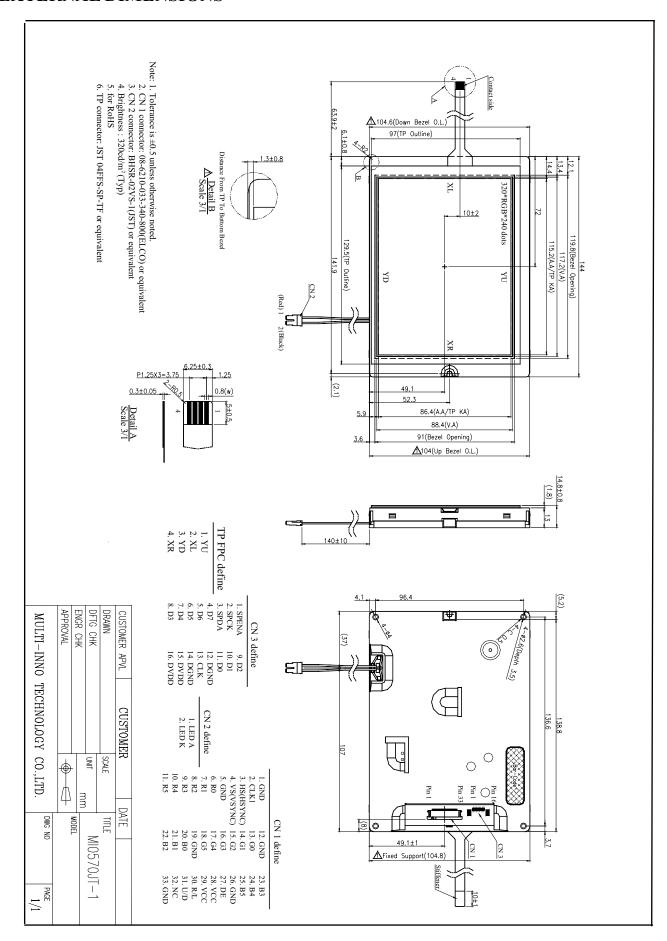
Item	Contents	Unit
LCD type	TFT	/
Size	5.7	Inch
Viewing direction	6:00	O' Clock
Gray scale inversion direction	12:00	O'Clock
$LCM(W \times H \times D)$	144.00×104.60×14.80	mm ³
Active area (W×H)	115.20×86.40	mm ²
Dot pitch (W×H)	0.12×0.36	mm ²
Number of dots	320 (RGB) × 240	/
Backlight type	21 LEDs	/
Interface type	RGB 18 bits	/
Color depth	262K	/
Color configuration	R.G.B stripe	/
Surface treatment	Anti-glare	/
Input voltage	3.3	V
With/Without TSP	With TSP	/
Weight	242	g

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift. Note 2: RoHS compliant;

Note 3: LCM weight tolerance: ± 5%.



■ EXTERNAL DIMENSIONS





MODULE NO.: MI0570JT-1 Ver 1.0

■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Power supply voltage	VCC	-0.3	7.0	V
Logic input voltage	VI	-0.3	VCC+0.3	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

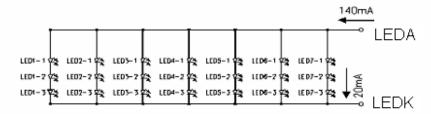
Parameter	Symbol	Min	Тур	Max	Unit
Power supply voltage	VCC	3.0	3.3	3.6	V
Power supply current	ICC	-	130	150	mA
Input voltage 'H' level	Vih	0.7VCC	-	3.6	V
Input voltage 'L' level	VIL	0	-	0.3VCC	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	9.9	-	10.5	V	
Forward current	If	-	140	-	mA	
Operating life time	-	10000	25000	-	Hrs	

Note 1: The "LED life time" is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25°C and IL =140mA.

Note2: VLED=LEDA-LEDK





■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol Condition		Min	Тур	Max	Unit	Remark	Note	
Response	time	Tr+Tf		-	50	80	ms	FIG 1.	4	
Contrast r	atio	Cr	θ=0°	300	350	-		FIG 2.	1	
Luminar uniform		δ WHITE	Ø=0° Ta=25°C	80	-	-	%	FIG 2.	3	
Surface Lum	inance	Lv		280	320	-	cd/m ²	FIG 2.	2	
			Ø = 90°	60	70	-	deg	FIG 3.		
Viovvina anal	la nomas	0	θ	Ø = 270°	40	50	-	deg	FIG 3.	6
Viewing angl	ie range	0	$\emptyset = 0$ °	60	70	-	deg	FIG 3.		
			Ø = 180°	60	70	-	deg	FIG 3.		
	Red	X		-	-	-				
	Red	у		-	-	-				
	Green	X	θ=0°	_	-	-				
CIE (x, y)	Green	у	Ø=0°	-	-	-		FIG 2.	5	
chromaticity	Blue	X	Ta=25℃	-	-	-		1102.		
	Diuc	у	1 a 25 C	-	-	-				
	White	X		0.25	0.30	0.35				
	VV IIIC	у		0.30	0.35	0.40				

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note 3. The uniformity in surface luminance $, \delta$ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE = Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.



FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

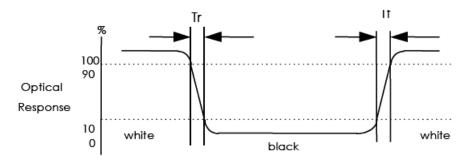
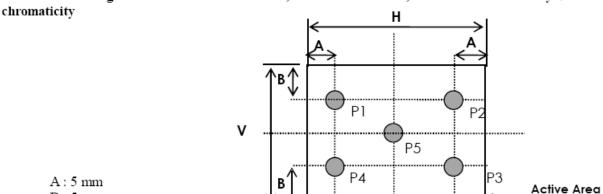


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y)

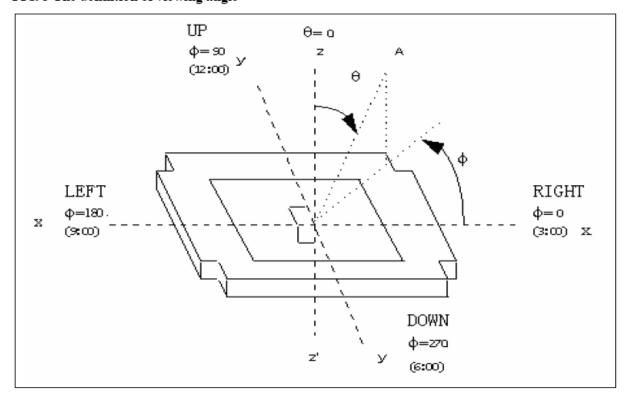


B:5 mm

H,V: Active Area

Light spot size ∅=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle





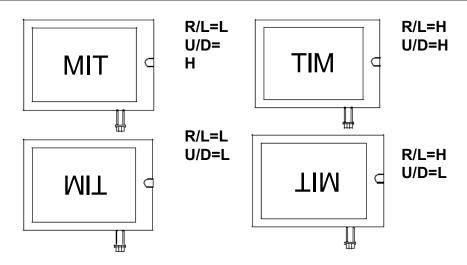
■ INTERFACE DESCRIPTION

1. P1 Input Pins Connection (To TTL571 control board)

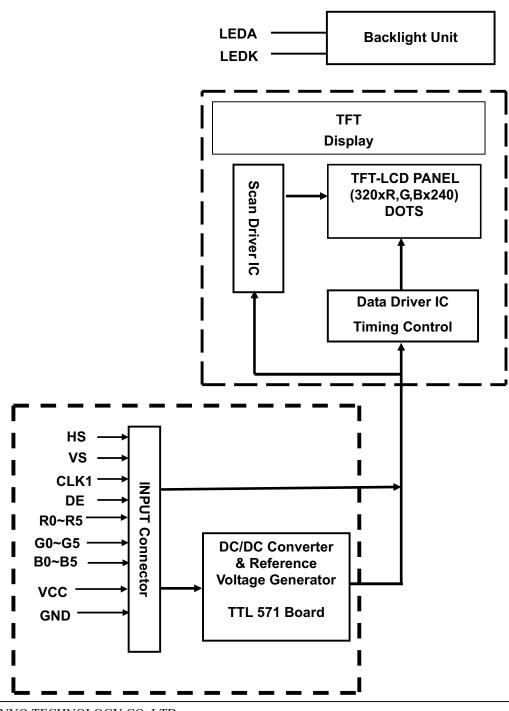
Pin No	Symbol	Function Rei						
1	GND	Ground for logic circuit						
2	CLK1	ata sampling clock						
3	HS (HSYNC)	Horizontal synchronous signal						
4	VS (VSYNC)	Vertical synchronous signal						
5	GND	Ground for logic circuit						
6	R0	Red pixel data(LSB)						
7	R1	Red pixel data						
8	R2	Red pixel data						
9	R3	Red pixel data						
10	R4	Red pixel data						
11	R5	Red pixel data(MSB)						
12	GND	Ground for logic circuit						
13	G0	Green pixel data(LSB)						
14	G1	Green pixel data						
15	G2	Green pixel data						
16	G3	Green pixel data						
17	G4	Green pixel data						
18	G5	Green pixel data(MSB)						
19	GND	Ground for logic circuit						
20	B0	Blue pixel data(LSB)						
21	B1	Blue pixel data						
22	B2	Blue pixel data						
23	B3	Blue pixel data						
24	B4	Blue pixel data						
25	B5	Blue pixel data(MSB)						
26	GND	Ground for logic circuit						
27	DE	Data Enable (connected to GND, if sync mode)						
28	Vcc	Power Supply: +3.3V						
29	Vcc	Power Supply: +3.3V						
30	R/L	Horizontal display mode select signal Left / Right Scan control input *2						
31	U/D	Vertical display mode select signal Up / Down Scan control input *2						
32	NC	No Connection						
33	GND	Ground for logic circuit						

^{*1} The horizontal display start timing is settled in accordance with a rising timing of DE signal. In case DE is fixed "Low", the horizontal start timing is determined as described in 8.1. Don't keep DE "High" during operation.





■ BLOCK DIAGRAM





■ APPLICATION NOTES

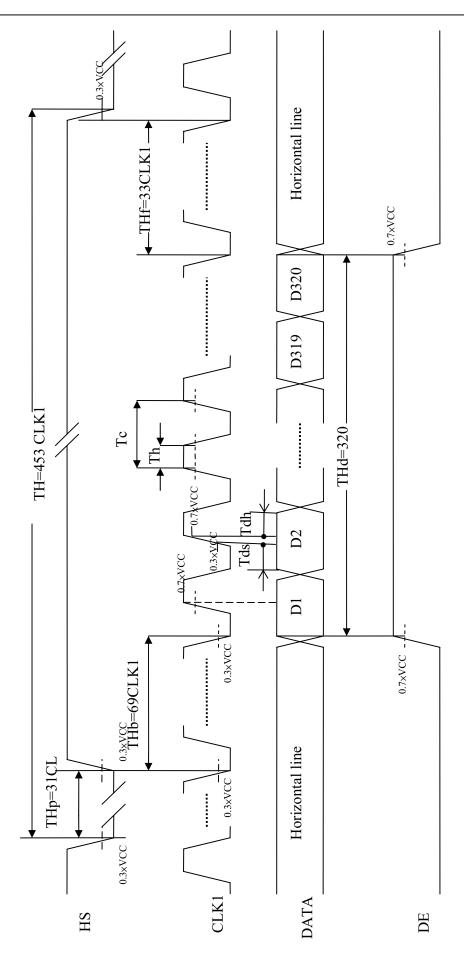
1. Input Signal Timing Specifications

Pa	rameter	Symbol	MIN.	TYP.	MAX.	Unit	Remarks
CLK	Frequency	1/Tc		7.21		MHz	
	Duty ratio	Th/Tc	40	50	60	%	
DATA	Setup time	Tds	12			ns	
	Hold time	Tdh	12			ns	
Horizontal	Period	TH		453		Clock	
synchronizing	Pulse width	THp		31		Clock	
	Horizontal period	THd		320		Clock	
	Blank porch	THb		69		Clock	
	Front porch	THf		33		Clock	
	Period	TV		267		Line	
Vertical	Pulse width	TVp		6		Line	
synchronizing	Vertical period	TVd		240		Line	
	Blank porch	TVb		18		Line	
	Front porch	TVf		3		Line	

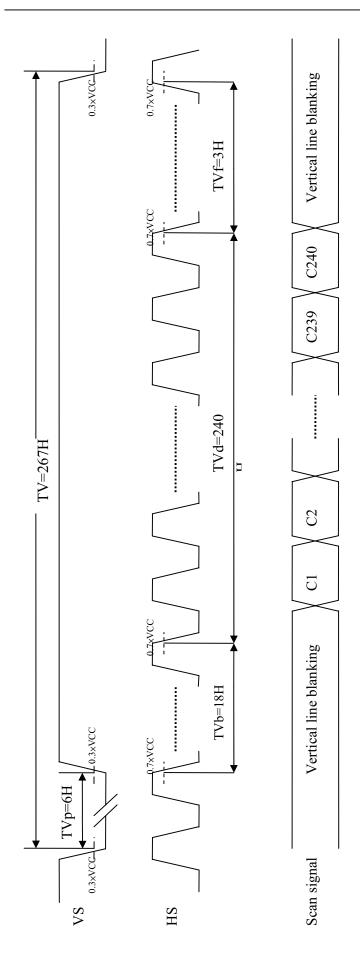
Note:

In case of using the slow frequency, the deterioration of display flicker etc may occur. The timing characteristics are basically fixed as above.





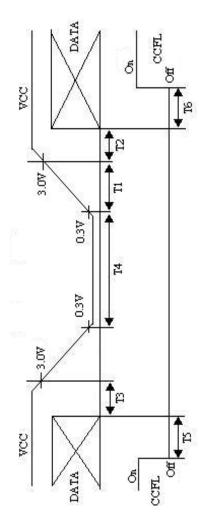






2. Power Off/On Sequence Timing



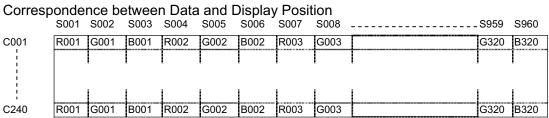




3. Color Data Input Assignment

			Data Signal																
				R	ed					Gre	en					BI	ue		
	R0	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	ВЗ	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
of Red	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(63) Green(0)/	1		1	1	1	1	0	U	0		0	0	0	0	0		0	0
	Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
Gray Scale	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
of Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
	Green(62) Green(63)	0	0	0	0	0	0	1	1	1	1		1	0	0	0	0	0	0
	Blue(0)/ Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Gray Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		:
of Blue	:	:		:	:	:	:	:		:	:	:	:	:	:	:	:	:	:
Diue	Blue (61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
	Blue (62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue (63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1









■ TOUCH PANEL CHARACTERISTICS

1.Input Method and Activation Force

Input Method	Average Activation Force
0.8mm dia. Delrin stylus	5gf~100gf
8.0mm dia. Silicon "finger"	5gf~100gf

2. Typical Optical Characteristics

ITEM	Parameter
Visible Light Transmission	≥80%
Haze	<10%

3. Electrical Specification

ITEM	Parameter		
Operating Voltage		DC 5V	
Contact current		According to individual design	
Circuit close resistance	X	220Ω~690Ω	
Circuit close resistance	Υ	300Ω~820Ω	
Circuit open resistance		≥20MΩat 25V DC	
Contact bounce		≤10ms	
Linear Test		≤1.5%	
Capacitance		<100nF	

4. Linearity

ITEM		Parameter
Linear Test Specification Direction	Х	≤1.5%
Linear rest Specification Direction	Υ	≤1.5%

5. Specification

İTEM	Parameter
Operating Temperature	-20°C~+70°C
Storage Temperature	-30°C~+80°C

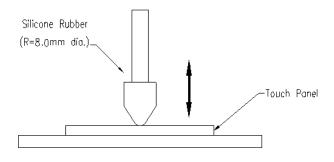
6. Durability test:

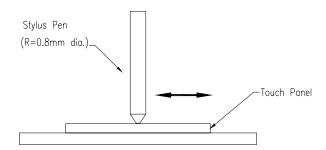
- 6.1 Touch panel is hit 1 millions times with a silicone rubber of R8 finger, hitting rate is by 250g at 2 times per second. The measurement must satisfy the following:
- Circuit close resistance: x 220Ω ~690 Ω ; y 300Ω ~820 Ω
- Circuit open resistance: ≥20MΩ at 25V DC
- Contact bounce: ≤10ms
- Linearity test: ≤1.5%

6.2 Stylus writing

Touch panel is drawn by R0.8 Delrin stylus pen, at 250g forces, repeat one inch by 100k times. The measurement must satisfy the following:

- Circuit close resistance: x 220Ω ~690 Ω ; y 300Ω ~820 Ω
- Circuit open resistance: ≥20MΩ at 25V DC
- Contact bounce: ≤10ms
- Linearity test: ≤1.5%







■ RELIABILITY TEST

No.	Test Item	Test Condition	
1	High Temperature Storage	80 ± 2 °C/240 hours	
2	Low Temperature Storage	-30±2°C/240 hours	
3	High Temperature Operating	70±2°C/240 hours	
4	Low Temperature Operating	-20±2℃/240 hours	
5	Temperature Cycle storage	-30±2°C~25~80±2°C × 200 cycles (30 min.) (5 min.) (30 min.)	
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH/240 hours}$	
7	Vibration Test (no-operation)	Frequency: 0~55Hz Amplitude:1.5mm Sweep time: 11min 6 cycles for each direction of X.Y.Z	
8	ESD test (No operation)	150pF,330Ω Air: ±15KV;Contact: ±8KV 10 time/point;4 point/panel face	



■ INSPECTION CRITERION

MI	OUTGOING QUALITY STANDARD	PAGE 1 OF 8
TITLE:FUNCTION	ONAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for Wider Screen TFT-LCD module product.

1. Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

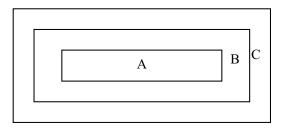
Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of $20\sim40W$ light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of Inspection Item.

3.1 Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

ZoneB+ZoneC= Around opaque edge area on TP.

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

3.2 Definition of some visual defect

Bright dot.	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.
Dark dot.	Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture, or pure whiter picture.
Dark / Bright Lines.	Lines on display which appear dark/bright and usually result from the contamination.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

4. Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1	All functional defects	 No display Display abnormally Open or missing segment Short circuit Excess power consumption Back-light no lighting, flickering and abnormal lighting. 	
4.2	Missing	Missing component	Major
4.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.4	Crack	Creaks tend to break are not allowed.	

5. Minor Defect

Items to be inspected	Inspection Standard				Classification of defects
Bright dot. defect.	Zone	1	Acceptable	Qty	
	Size(mm)	A	В	C	
	Ф≤0.15				
$\Phi = (x+y)/2$	0.15<Φ≤0.25	Φ≤0.25 N≤6.			
	0.25< Ф ≤ 0.50	0.25<Φ≤0.50 N≤2			
					Minor
	Zone		Acceptable	Q'ty	
	Size(mm)	A	В	С	
	Ф ≤ 0.15	Accep	otable		
	0.15< Φ≤0.30) N	€6	Acceptable	
	0.30<Φ≤0.5	50 N	€4		
Bright / Dark line.	$0.01 < W \le 0.10,$ $N \le 1$		≤ 1.50,	Acceptable	
	inspected Bright dot. defect. Φ=(x+y)/2 Dark dot defect.	inspected Bright dot. defect. $\Phi = (x+y)/2$ Dark dot defect. 0.15 < \Phi \le 0.25$ $0.25 < \Phi \le 0.50$ Zone Size(mm) $0.15 < \Phi \le 0.30$ $0.30 < \Phi \le 0.5$ Bright / 0.01 < W \le 0.10,	Inspection S Bright dot. defect.	Inspection Standard Bright dot. defect. Zone Acceptable $\Phi \leq 0.15$ Acceptable (clustering of spot not allowed) $\Phi = (x+y)/2$ $0.15 < \Phi \leq 0.25$ $0.25 < \Phi \leq 0.50$ $0.25 < \Phi \leq 0.50$ $0.25 < \Phi \leq 0.50$ $0.15 < \Phi \leq 0.15$ $0.15 < \Phi \leq 0.30$ $0.15 < \Phi \leq 0.50$ $0.15 < $	Inspection Standard Bright dot. defect. Size(mm) A

Note: 1. Total defective dots shall not exceed 6 pcs.

- 2. Minimum distance between defective dots is more than 5mm.
- 3. 2 Adjacent dark sub pixel defect or bright sub pixel defect is not more than 1pair.
- 4. W: Width, L: Length, N: Count.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

Item No	Items to be inspected		Inspection S	tandard			Classification of defects
	Linear defect	Linear defect Size(m) A		Accept	Acceptable Qty		Minor
	Foreign material				Zone		
	under polarizer,	L(Length)	W(Width)	A	В	С	
		Ignore	W≤0.05	Accept	table	Acc	
		L≤5.0	0.05 <w≤0.15< td=""><td>N:</td><td>≤5</td><td>Acceptable</td><td></td></w≤0.15<>	N:	≤ 5	Acceptable	
		5.0≤L	0.15≤W		0	ole	
5.4	Circular Defect,						Minor
	Foreign material under polarizer,	Zo	ne A	cceptable			
	y	Size(mm)	A	В	С		
		Ф ≤ 0.25	Accept		- Acceptal	ole	
	$\Phi = (x+y)/2$	$0.25 < \Phi \leqslant 0.5$		N≤4 0			
		0.50 ≤ Ф		0			
		dimension	n position should				Minor
		is not allo 5.4.2 Dirt on po Dirt which 5.4.3 Polarizer	olarizer 1 can be wiped eas	ily should			
5.5	Polarizer	5.4.2 Dirt on po	olarizer n can be wiped eas Nick & Dent	ily should	d be accepted		
5.5	Polarizer defect.	5.4.2 Dirt on po Dirt which 5.4.3 Polarizer	olarizer n can be wiped eas Nick & Dent		d be accepted		
5.5		5.4.2 Dirt on po Dirt which 5.4.3 Polarizer	olarizer n can be wiped eas Nick & Dent	cceptable	d be accepted		
5.5		5.4.2 Dirt on po Dirt which 5.4.3 Polarizer	olarizer of can be wiped eas Nick & Dent A	Zone B	d be accepted		
5.5		5.4.2 Dirt on po Dirt which 5.4.3 Polarizer	olarizer n can be wiped eas Nick & Dent A A A A A A	Zone B able	d be accepted		







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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

Polarizer defect	Size(1)	A Ac 0.3 Ac 0 ≤ 1.0 0 ≤ 1.5 1.5	Acceptal Zor B ceptable 3 1 0	ble Qty ne C Acceptable	Minor
	$ \begin{array}{c c} & \Phi \leqslant \\ \hline & 0.3 < \Phi \\ \hline & 1.0 < \Phi \\ \hline & \Phi > \\ \end{array} $ 5.4.5 Polarizer (i) If the assemble	A 0.3 Ac $0 \le 1.0$ $0 \le 1.5$ $0 \le 1.5$ Scratch Polarizer scratch	Zon B ceptable 3 1 0	C Acceptable	
	$ \begin{array}{c c} & \Phi \leqslant \\ \hline & 0.3 < \Phi \\ \hline & 1.0 < \Phi \\ \hline & \Phi > \\ \end{array} $ 5.4.5 Polarizer (i) If the assemble	A 0.3 Ac $0 \le 1.0$ $0 \le 1.5$ $0 \le 1.5$ Scratch Polarizer scratch	B ceptable 3 1 0	C Acceptable	
	0.3< Φ 1.0< Φ 5.4.5 Polarizer (i) If the assemble assemble content of the assemble content of the content of	60.3 Ac $0 \le 1.0$ $0 \le 1.5$ $0 \le 1.5$ $0 \le 1.5$ $0 \le 1.5$ Scratch Polarizer scratch	ceptable 3 1 0 1 can be	Acceptable	
	0.3< Φ 1.0< Φ 5.4.5 Polarizer (i) If the assemble assemble content of the assemble content of the content of	o≤1.0 o≤1.5 o1.5 scratch Polarizer scratch	3 1 0		
	1.0< Φ > 5.4.5 Polarizer (i) If the assemble as a second assemble as a second assemble as a second assemble as a second assemble as a second assemble as a second assemble as a second as a seco	e ≤1.5 1.5 scratch Polarizer scratch	1 0		
	Φ >5.4.5 Polarizer(i) If the assemble	scratch Polarizer scratch	0 can be		
	5.4.5 Polarizer (i) If the assemble	scratch Polarizer scratch	a can be	seen ofter cove	
	(i) If the assemble	Polarizer scratch		seen ofter cove	
delect	(ii) If the non-ope judge b		ch can be nor som	ndition, judge by the seen only in the special angle totable Qty Zone	y n
		judge b Siz L(Length) Ignore $1.0 < L \le 5.0$	judge by the following.	judge by the following.	judge by the following.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

Item No	Items to be inspected			Inspection Standard		Classificatio n of defects
		(i) Crack Cracks a	are not allo	owed.		Minor
		(ii) TFT chi	ps on corn	er		Minor
5.7	Glass defect	X ≤3.0	Y ≤3.0	Not more than the	Acceptable N≤3.	
				thickness of glass. of terminal shall not be pose perimeter seal.	e allowed to extend	1
		(iii)Usual su	irface crac	ks	 	Minor
		X	Y	Z	Acceptable	
		≤1.5	≤1.5	Not more than the thickness of glass.		





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

6. TP Cosmetic Defect.

Items to be inspected	Inspection Standard			Classification of defects	
Black and white Spot defect Foreign Particle,	For dark/white spot, size Φ is defined as $\Phi = \frac{(x+y)}{2}$				
		one Ac	Acceptable Qty		
	Size(mm)	A	B+C		Minor
	Φ≤0.15 I _ξ		ore		Minor
	0.15< Ф ≤ 0.25		distance 5mm		
	0.25< Φ≤0.	.50 4		over	
	Φ>0.5				
	Total defective dots shall not exceed 6 pcs on the same TP.				
Items to be inspected	Inspection Standard			Classification of defects	
Black line, White					
	Size(mm)		Acceptable Qty		
	hite	W(Width)	Zone		
			A B+C		
Scratch,	Ignore	W≤0.03	Ignore		Minor
Foreign material under film,	L≤5.0	$0.03 < W \le 0.05$	5	distance 5mm over	Willion
	L≤5.0	0.05 <w≤0.1< td=""><td>2</td><td></td></w≤0.1<>	2		
		0.1 <w< td=""><td>0</td><td></td></w<>	0		
	Black and white Spot defect Foreign Particle, Items to be inspected Black line, White line, Scratch, Foreign material under	Black and white Spot defect Foreign Particle, Black line, White line, Scratch, Foreign material under For dark/white spans as $\Phi = \frac{(x+y)}{2}$ Size(mm) Size(mm) Defect S	For dark/white spot, size Φ is define as $\Phi = \frac{(x+y)}{2}$ Black and white Spot defect Foreign Particle, $0.15 < \Phi \le 0.25$ $0.25 < \Phi \le 0.50$ $0.25 < \Phi \le 0.50$ Total defective dots shall not except a specific shall not exc	For dark/white spot, size Φ is defined as $\Phi = \frac{(x+y)}{2}$ Black and white Spot defect Foreign Particle, $0.15 < \Phi \le 0.25$ $0.25 < \Phi \le 0.50$ Total defective dots shall not exceed 6 pcs on TP. Items to be inspected Size(mm) Accepta L(Length) W(Width) A B+C Inspection Standard Size(mm) Accepta L(Length) W(Width) A B+C Ignore U(Length) V(Width) L(Source) For dark/white spot, size Φ is defined as $\Phi = \frac{(x+y)}{2}$ Black and white Spot defect Foreign Particle, $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

6. TP Cosmetic Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
		(i) Chips on corner X X Y Y X X X X	Minor
	TP defect	(ii)Usual surface cracks $X(mm) = X(mm)$	Minor
		(iii) Crack Cracks tending to break are not allowed.	Major
6.4	Total number of dots	The total number of luminous dots, dark dots, contamination particles, bubbles, scratch defects, pinholes must not exceed 10 /piece on the same TP.	





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

Item No	Inspection Standard		Classification of defects
1	Difference in Spec.	None allowed	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing No soldering bridge No cold soldering	Major Major Minor
4	Resist flaw on Printed Circuit Boards	visible copper foil (Ø0.5mm or more) on substrate pattern.	Minor
5	Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed \emptyset 0.2mm).	Minor Minor
6	Stain	No stain to spoil cosmetic badly.	Minor
7	Plate discoloring	No plate fading, rusting and discoloring.	Minor
9	Solder amount 1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB') Solder to reach the Components side of PCB.	Minor
	2. Flat packages	Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'. Lead form to be assume over solder.	Minor
	3. Chips	$(3/2) H \ge h \ge (1/2) H$	Minor
	Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball d ≤ 0.15 mm.	Minor
		b.The quantity of solder balls or solder. Splashes isn't beyond 5 in 600 mm ² .	Minor
		c.Solder balls/Solder splashes do not violate minimum electrical clearance. d.Solder balls/Solder splashes must be entrapped / encapsulated or attached to the metal surface .	Major Minor
		Note: Entrapped/encapsulated/attached is intended to mean that normal service environment of the product will not cause a solder ball to become dislodged.	



1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling



and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.



2 Handling precaution for LCM

- 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
- 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



Please don't touch IC directly.



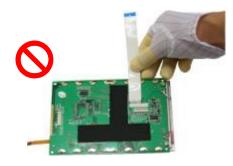
Please don't hold the surface of panel.



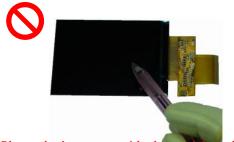
Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others 其它

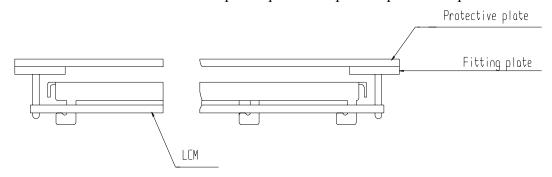
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
Product	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
Troduct			Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- If you have special requirement about reliability condition, please let us know before you start the test on our samples.